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5821997-3 Product Details

Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card
- Socket Style = SIMM
- . Gold (30) Contact Plating, Mating Area, Material
- 72 Positions
- 1.27 mm Centerline

View all Features



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Print

5821997-3

TE Internal Number: 5821997-3 Active

No Image Available











Documentation & Additional Information

Product Drawings:

CONNECTOR, MICRO-EDGE, .050, VERT, GOLD PL, W/METAL ... (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

None Available

Application Specifications:

MICRO-EDGE SIMM (Single In-Line Memory Module) Conne... (PDF, English)

Instruction Sheets:

None Available

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version B)
- 3D Model (IGES, Version B)
- 3D Model (STEP, Version B)

Additional Information:

· Product Line Information

Additional Product Images:

Product Photo

Related Products:

Tooling

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Housing Features:

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Socket Style = SIMM PCB Mount Style = Through Hole
- Module Orientation = Vertical
- Polarization = Left

Termination Features:

- Insertion Style = Cam-In
- Termination Post Length (mm [in]) = 3.05 [0.120], 3.66 [0.144]
- Solder Tail Contact Plating = Tin over Nickel

Configuration Features:

Number of Positions = 72

Centerline (mm [in]) = 1.27 [0.050]

UL Flammability Rating = UL 94V-0

Housing Material = Liquid Crystal Polymer (LCP)

Number of Rows = Single

Center Key (mm [in]) = None

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Packaging Features:

Packaging Method = Tube

Other:

- Brand = TE Connectivity
- Proprietary Name = MICRO-EDGE

Dimensions: Center Retention Hole Diameter (mm [in]) = 2.45 [0.096]

Body Features: Socket Type = Memory Card

Ejector Location = None

- Center Post = With
- Latch Material = Brass Latch Plating = Nickel
- Mount Type = Printed Circuit Board

Contact Features:

- Contact Plating, Mating Area, Material = Gold (30)
- Contact Base Material = Phosphor Bronze
- Retention Post(s) Location = Center

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